

Application Serial No. 09/994,283  
Reply to Office Action of January 10, 2005

PATENT  
Docket: CU-2732

### **Amendments To The Claims**

The listing of claims presented below will replace all prior versions, and listings, of claims in the application.

#### **Listing of claims:**

1. (original) A liquid crystal display device comprising:
  - a supporting column provided for an upper substrate and vertically extended from the upper substrate so as to maintain a uniform cell gap;
  - a contact part provided for a common line disposed at a peripheral region outside an active area of a lower substrate confronting the upper substrate, wherein the contact part faces the supporting column at a corresponding position so as to guide a communication between the supporting column and the common line; and
  - an electrically conductive layer formed on surfaces of the supporting column and the upper substrate, wherein a portion of the electrically conductive layer on the supporting column is joined to the common line within the contact part so as to establish a signal interconnection between the lower substrate and the upper substrate.
2. (original) The liquid crystal display device of claim 1, wherein an insulating layer is further provided for the common line, and the contact part is a contact hole formed in the insulating layer so as to expose a portion of the common line.
3. (original) A method for fabricating a liquid crystal display device, comprising:
  - providing a supporting column provide for an upper substrate, wherein the

Application Serial No. 09/994,283  
Reply to Office Action of January 10, 2005

PATENT  
Docket: CU-2732

supporting column is vertically extended from the upper substrate so as to maintain a uniform cell gap;

forming an electrically conductive layer on surfaces of the supporting column and the upper substrate;

providing a contact part for a common line disposed at a peripheral region outside an active area of a lower substrate confronting the upper substrate, wherein the contact part faces the supporting column at a corresponding position; and

uniting the lower substrate and the upper substrate so that a portion of the electrically conductive layer on the supporting column is joined to the common line within the contact part, thereby establishing a signal interconnection between the lower substrate and the upper substrate.

4. (original) The method of claims 3, wherein the providing of the contact part includes providing an insulating layer for the common line and forming a contact hole in the insulating layer so as to expose a portion of the common line.
5. (original) The method of claim 3, wherein the electrically conductive layer includes an indium tin oxide (ITO) layer.